



Material Content Data Sheet



Sales Product Name		IPD80R4K5P7		Issued		20. July 2018		
MA#		MA001469196						
Package		PG-TO252-3-341		Weight*		386.83 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	0.679	0.18	0.18	1755	1755
leadframe	non noble metal	iron	7439-89-6	0.248	0.06		642	
	inorganic material	phosphorus	7723-14-0	0.075	0.02		193	
	non noble metal	copper	7440-50-8	248.124	64.13	64.21	641425	642263
wire	non noble metal	aluminium	7429-90-5	0.069	0.02	0.02	179	179
encapsulation	organic material	carbon black	1333-86-4	0.397	0.10		1026	
	plastics	epoxy resin	-	12.035	3.11		31112	
	inorganic material	silicondioxide	60676-86-0	119.821	30.98	34.19	309752	341890
leadfinish	non noble metal	tin	7440-31-5	3.740	0.97	0.97	9668	9668
plating	non noble metal	nickel	7440-02-0	0.509	0.13	0.13	1315	1315
solder	noble metal	silver	7440-22-4	0.028	0.01		73	
	non noble metal	tin	7440-31-5	0.023	0.01		59	
	non noble metal	lead	7439-92-1	1.082	0.28	0.30	2798	2930
heatspreader	non noble metal	copper	7440-50-8	0.000	0.00		1	
	non noble metal	iron	7439-89-6	0.000	0.00		1	
	inorganic material	phosphorus	7723-14-0	0.000	0.00	0.00	1	0
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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